

## X2QFN18, 2.0x2.8, 0.4P CASE 722AB ISSUE O

**DATE 17 MAY 2016** 

- IOTES:

  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

  2. CONTROLLING DIMENSION: MILLIMETERS

  3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.25 MM FROM THE TERMINAL TIP.
- COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

NO TIELETTO THE TEITING				
	MILLIMETERS			
DIM	MIN	MAX		
Α		0.40		
A1	0.00	0.05		
A3	0.13 REF			
b	0.13	0.23		
D	2.00 BSC			
D2	0.90	1.00		
Е	2.80 BSC			
E2	1.70	1.80		
е	0.40 BSC			
L	0.25	0.35		
L2	0.11 REF			
L3	0.14	REF		

## **GENERIC** MARKING DIAGRAM\*



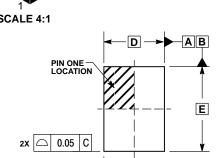
= Specific Device Code XX

= Month Code Μ

= Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G", may or not be present.



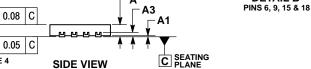
**TOP VIEW** 

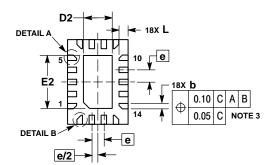
С 0.05

NOTE 4

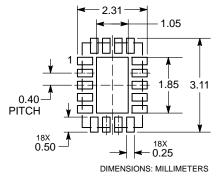








## RECOMMENDED **MOUNTING FOOTPRINT**



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DESCRIPTION:	X2QFN18, 2.0 X 2.8, 0.4P	PAGE 1 OF 2
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PAGE 2 OF 2

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